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Wireless Components

ASK/FSK Transmitter 915 MHz TDA 5102 Version 1.1

Specification October 2001

Revision Hist	Revision History		
Current Versio	n: 1.1 as of Octob	per 2001	
Previous Versi	on: 1.0, March 200)1	
Page (in previous Version)	Page (in current Version)	Subjects (major changes since last revision)	
2-2, 5-3, 5-6	2-2, 5-3, 5-6	Frequency range increased	
3-3 3-6	3-3 3-6	ESD-structures added to interface schematics	
3-10, 5-3	3-10, 5-3	Typical value for Power-Down-Mode current added	
4-8 4-10		Description of Application board deleted	
5-2	5-2	Supply voltage range added to Absolute Maximum Ratings	
5-2	5-2	ESD integrity specified in detail	
5-3, 5-6	5-3, 5-6	Loop filter voltages adapted	
5-4, 5-7	5-4, 5-7	Saturation voltage of Clock Driver Output reduced	
5-5, 5-8	5-5, 5-8	Output Power Tolerances reduced	

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Product Info

General Description	The TDA 5102 is a single chip ASK/		
	FSK transmitter for the frequency band 905-925 MHz. The IC offers a high level of integration and needs only a few external components. The device contains a fully integrated PLL synthe sizer and a high efficiency power ampli fier to drive a loop antenna. A specia circuit design and an unique powe amplifier design are used to save cur rent consumption and therefore to save battery life. Additionally features like a power down mode, a low power detect a selectable crystal oscillator frequency and a divided clock output are imple mented. The IC can be used for both		
	mented. The IC can be used for both ASK and FSK modulation.		
Features	 fully integrated frequency synthe- 	power down mod	
	sizer	Iow voltage sens	
	 VCO without external components 	 selectable crysta 	
	 high efficiency power amplifier 	7.15 MHz/14.3 N	
	frequency range 905-925 MHz	programmable di	

- ASK/FSK modulation
- Iow supply current (typically 7mA)
- voltage supply range 2.1 4 V
- Applications
- Keyless entry systems
- Remote control systems

- bde
- sor
- al oscillator MHz
- programmable divided clock output for µC
- Iow external component count
- Alarm systems
- Communication systems

Ordering Information

Infineon

Туре	Ordering Code	Package	
TDA 5102	Q67036-A1175	P-TSSOP-16	
available on tape and reel			



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Product Description



2.1 Overview

The TDA 5102 is a single chip ASK/FSK transmitter for the frequency band 905-925 MHz. The IC offers a high level of integration and needs only a few external components. The device contains a fully integrated PLL synthesizer and a high efficiency power amplifier to drive a loop antenna. A special circuit design and an unique power amplifier design are used to save current consumption and therefore to save battery life. Additional features like a power down mode, a low power detect, a selectable crystal oscillator frequency and a divided clock output are implemented. The IC can be used for both ASK and FSK modulation.

2.2 Applications

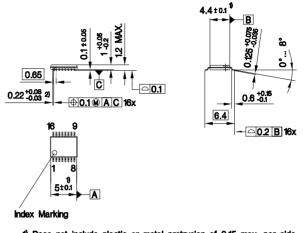
- Keyless entry systems
- Remote control systems
- Alarm systems
- Communication systems

2.3 Features

- fully integrated frequency synthesizer
- VCO without external components
- high efficiency power amplifier
- frequency range 905-925 MHz
- ASK/FSK modulation
- Iow supply current (typically 7 mA)
- voltage supply range 2.1 4 V
- power down mode
- Iow voltage sensor
- selectable crystal oscillator 7.15 MHz/14.3 MHz
- programmable divided clock output for μC
- Iow external component count



2.4 Package Outlines



1) Does not include plastic or metal protrusion of 0.15 max. per side 2) Does not include dambar protrusion

Figure 2-1 P-TSSOP-16

Contents of this Chapter

3.1	Pin Configuration
3.2	Pin Definitions and Functions
3.3	Functional Block diagram
3.4	Functional Blocks
3.4.1	PLL Synthesizer
3.4.2	Crystal Oscillator
3.4.3	Power Amplifier
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3.4.5.1	Power Down Mode
3.4.5.2	PLL Enable Mode
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3.1 Pin Configuration

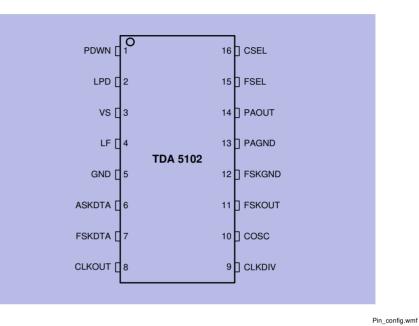


Figure 3-1 IC Pin Configuration

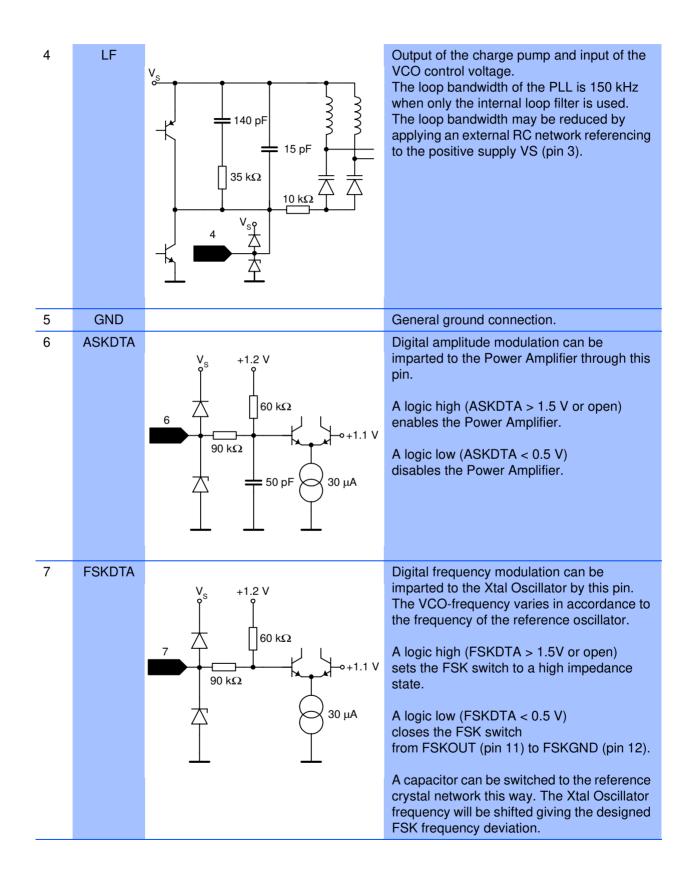
Table 3-1		
Pin No.	Symbol	Function
1	PDWN	Power Down Mode Control
2	LPD	Low Power Detect Output
3	VS	Voltage Supply
4	LF	Loop Filter
5	GND	Ground
6	ASKDTA	Amplitude Shift Keying Data Input
7	FSKDTA	Frequency Shift Keying Data Input
8	CLKOUT	Clock Driver Output
9	CLKDIV	Clock Divider Control
10	COSC	Crystal Oscillator Input
11	FSKOUT	Frequency Shift Keying Switch Output
12	FSKGND	Frequency Shift Keying Ground
13	PAGND	Power Amplifier Ground
14	PAOUT	Power Amplifier Output
15	FSEL	Frequency Range Selection: Has to be left open for 915 MHz operation
16	CSEL	Crystal Frequency Selection (7.15 or 14.3 MHz)



3.2 Pin Definitions and Functions

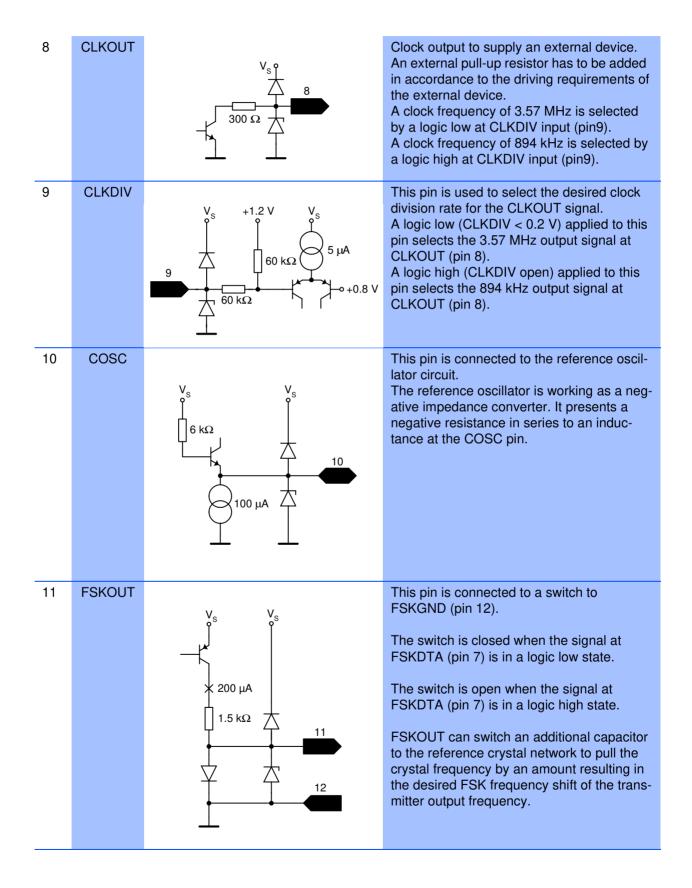
Table	Table 3-2					
Pin No.	Symbol	Interface Schematic	Function			
1	PDWN	1 $V_{S} + 40 \mu A * (ASKDTA+FSKDTA)$ $5 k\Omega$ $150 k\Omega$ $250 k\Omega$	Disable pin for the complete transmitter cir- cuit. A logic low (PDWN < 0.7 V) turns off all transmitter functions. A logic high (PDWN > 1.5 V) gives access to all transmitter functions. PDWN input will be pulled up by 40 μA inter- nally by either setting FSKDTA or ASKDTA to a logic high-state.			
2	LPD	V_{s} $40 \mu A$ 2 300Ω	This pin provides an output indicating the low-voltage state of the supply voltage VS. VS < 2.15 V will set LPD to the low-state. An internal pull-up current of 40 μ A gives the output a high-state at supply voltages above 2.15 V.			
3	VS		This pin is the positive supply of the trans- mitter electronics. An RF bypass capacitor should be con- nected directly to this pin and returned to GND (pin 5) as short as possible.			













12	FSKGND		Ground connection for FSK modulation out- put FSKOUT.
13	PAGND		Ground connection of the power amplifier. The RF ground return path of the power amplifier output PAOUT (pin 14) has to be concentrated to this pin.
14	PAOUT		RF output pin of the transmitter. A DC path to the positive supply VS has to be supplied by the antenna matching net- work.
15	FSEL	V _s +1.2 V 30 kΩ 90 kΩ 30 μA	 This pin has to be left open to select the 915 MHz transmitter frequency range. A logic low (FSEL < 0.5 V) applied to this pin sets the transmitter to the 457 MHz frequency range. A logic high (FSEL open) applied to this pin sets the transmitter to the 915 MHz frequency range.
16	CSEL	16 16 16 16 16 16 16 16 16 16	 This pin is used to select the desired reference frequency. A logic low (CSEL < 0.2 V) applied to this pin sets the internal frequency divider to accept a reference frequency of 7.15 MHz. A logic high (CSEL open) applied to this pin sets the internal frequency divider to accept a reference frequency of 14.3 MHz.

3.3 Functional Block diagram

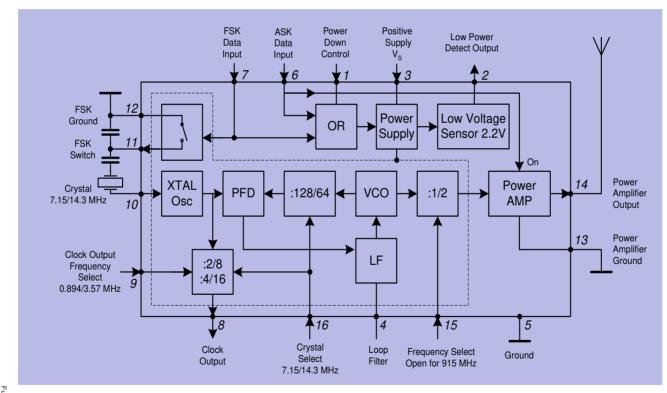


Figure 3-2 Functional Block diagram

Funct_Block_Diagram.wmf



3.4 Functional Blocks

3.4.1 PLL Synthesizer

The Phase Locked Loop synthesizer consists of a Voltage Controlled Oscillator (VCO), an asynchronous divider chain, a phase detector, a charge pump and a loop filter. It is fully implemented on chip. The tuning circuit of the VCO consisting of spiral inductors and varactor diodes is on chip, too. Therefore no additional external components are necessary. The nominal center frequency of the VCO is 915 MHz. The oscillator signal is fed both, to the synthesizer divider chain and to the power amplifier. The overall division ratio of the asynchronous divider chain is 128 in case of a 7.15 MHz crystal or 64 in case of a 14.3 MHz crystal and can be selected via CSEL (pin 16). The phase detector is a Type IV PD with charge pump. The passive loop filter is realized on chip.

3.4.2 Crystal Oscillator

The crystal oscillator operates either at 7.15 MHz or at 14.3 MHz.

The reference frequency can be chosen by the signal at CSEL (pin 16).

Table 3-3	
CSEL (pin 16)	Crystal Frequency
Low ¹⁾	7.15 MHz
Open ²⁾	14.3 MHz
 Low: Voltage at pin < 0.2 V Open: Pin open 	

For both quartz frequency options, 894 kHz or 3.57 MHz are available as output frequencies of the clock output CLKOUT (pin 8) to drive the clock input of a micro controller.

The frequency at CLKOUT (pin 8) is controlled by the signal at CLKDIV (pin 9)

Table 3-4	
CLKDIV (pin 9)	CLKOUT Frequency
Low ¹⁾	3.57 MHz
Open ²⁾	894 kHz
1) Low: Voltage at pin < 0.2 V 2) Open: Pin open	



To achieve FSK transmission, the oscillator frequency can be detuned by a fixed amount by switching an external capacitor via FSKOUT (pin 11).

The condition of the switch is controlled by the signal at FSKDTA (pin 7).

Table 3-5		
FSKDT	ΓA (pin7)	FSK Switch
Lo	ow ¹⁾	CLOSED
Open ²	⁾ , High ³⁾	OPEN
2) Open: P	oltage at pin < 0.5 V in open oltage at pin > 1.5 V	

3.4.3 Power Amplifier

For operation at 915 MHz, the power amplifier is fed directly from the voltage controlled oscillator. It is possible to feed the power amplifier with the VCO frequency divided by 2. This is controlled by FSEL (pin 15) as described in the table below.

Table 3-6	
FSEL (pin 15)	Radiated Frequency Band
Low ¹⁾	457 MHz
Open ²⁾	915 MHz
1) Low: Voltage at pin < 0.5 V	

2) Open: Pin open

The Power Amplifier can be switched on and off by the signal at ASKDTA (pin 6).

Table 3-7	
ASKDTA (pin 6)	Power Amplifier
Low ¹⁾	OFF
Open ²⁾ , High ³⁾	ON
 Low: Voltage at pin < 0.5 V Open: Pin open 	

3) High: Voltage at pin > 1.5 V

The Power Amplifier has an Open Collector output at PAOUT (pin 14) and requires an external pull-up coil to provide bias. The coil is part of the tuning and matching LC circuitry to get best performance with the external loop antenna. To achieve the best power amplifier efficiency, the high frequency voltage swing at PAOUT (pin 14) should be twice the supply voltage.

The power amplifier has its own ground pin PAGND (pin 13) in order to reduce the amount of coupling to the other circuits.



3.4.4 Low Power Detect

The supply voltage is sensed by a low power detector. When the supply voltage drops below 2.15 V, the output LPD (pin 2) switches to the low-state. To minimize the external component count, an internal pull-up current of 40 μ A gives the output a high-state at supply voltages above 2.15 V.

The output LPD (pin 2) can either be connected to ASKDTA (pin 6) to switch off the PA as soon as the supply voltage drops below 2.15 V or it can be used to inform a micro-controller to stop the transmission after the current data packet.

3.4.5 Power Modes

The IC provides three power modes, the POWER DOWN MODE, the PLL ENABLE MODE and the TRANSMIT MODE.

3.4.5.1 Power Down Mode

In the POWER DOWN MODE the complete chip is switched off.

The current consumption is typically 0.3 nA at 3 V 25°C.

3.4.5.2 PLL Enable Mode

In the PLL ENABLE MODE the PLL is switched on but the power amplifier is turned off to avoid undesired power radiation during the time the PLL needs to settle. The turn on time of the PLL is determined mainly by the turn on time of the crystal oscillator and is typically less than 1 msec, depending on the crystal.

The current consumption is typically 3.5 mA.

3.4.5.3 Transmit Mode

In the TRANSMIT MODE the PLL is switched on and the power amplifier is turned on too.

The current consumption of the IC is typically 7 mA when using a proper transforming network at PAOUT, see Figure 4-1.

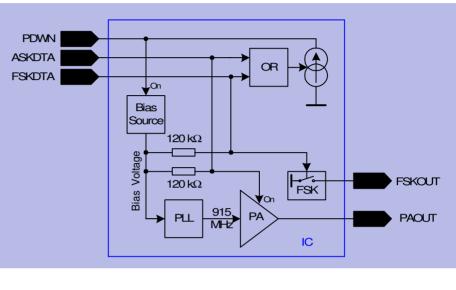
3.4.5.4 Power mode control

The bias circuitry is powered up via a voltage V > 1.5 V at the pin PDWN (pin 1). When the bias circuitry is powered up, the pins ASKDTA and FSKDTA are pulled up internally.

Forcing the voltage at the pins low overrides the internally set state.

Alternatively, if the voltage at ASKDTA or FSKDTA is forced high externally, the PDWN pin is pulled up internally via a current source. In this case, it is not necessary to connect the PDWN pin, it is recommended to leave it open.





The principle schematic of the power mode control circuitry is shown in Figure 3-5.

Power_Mode.wmf

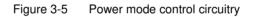


Table 3-8 provides a listing of how to get into the different power modes

Table 3-8				
PDWN	FSKDTA	ASKDTA	MODE	
Low ¹⁾	Low, Open	Low, Open	POWER DOWN	
Open ²⁾	Low	Low		
High ³⁾	Low, Open, High	Low	PLL ENABLE	
Open	High	Low		
High	Low, Open, High	Open, High		
Open	High	Open, High	TRANSMIT	
Open	Low, Open, High	High		
 Low: Voltage at pin < 0.7 V (PDWN) Voltage at pin < 0.5 V (FSKDTA, ASKDTA) Open: Pin open High: Voltage at pin > 1.5 V 				

Other combinations of the control pins PDWN, FSKDTA and ASKDTA are not recommended.

ASK_mod.wmf

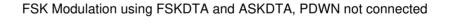


Modes: Power Down \rightarrow PLL Enable Transmit High FSKDTA Low Open, High Low to DATA dow tomin. 1 msec.

3.4.6 Recommended timing diagrams for ASK- and FSK-Modulation

ASK Modulation using FSKDTA and ASKDTA, PDWN not connected

Figure 3-6 ASK Modulation



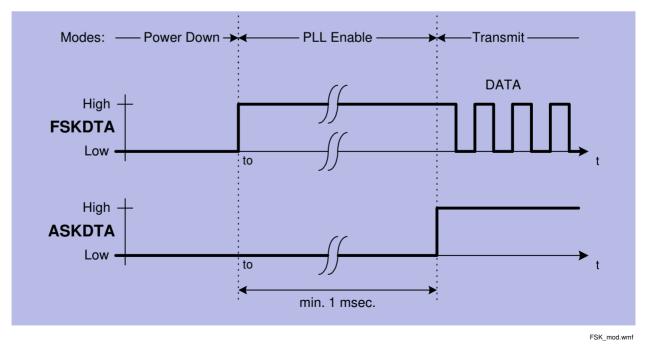
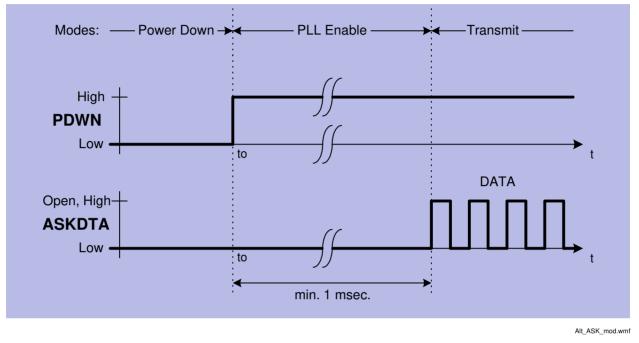


Figure 3-7 FSK Modulation





Alternative ASK Modulation, FSKDTA not connected.

Figure 3-8 Alternative ASK Modulation

Alternative FSK Modulation

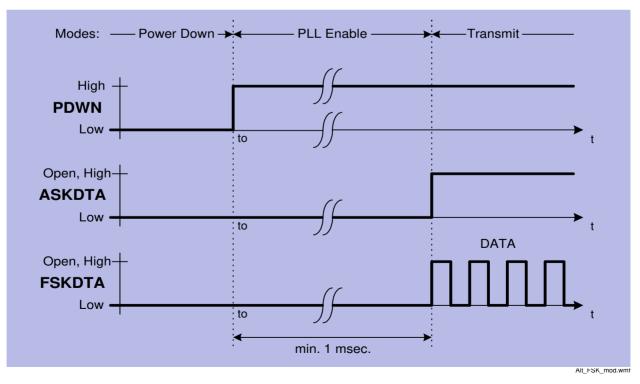


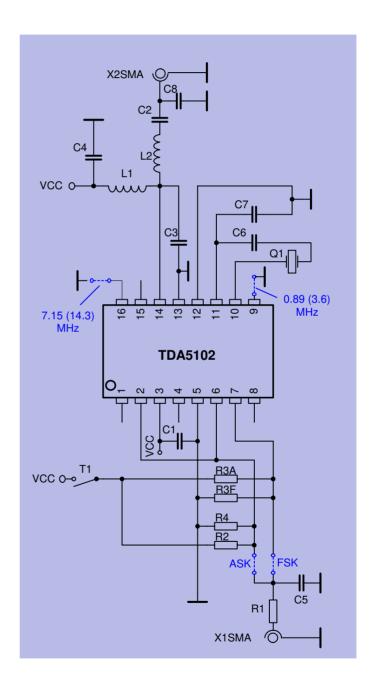
Figure 3-9 Alternative FSK Modulation



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4.3	Bill of material (50 Ohm-Output Testboard)	. 4-4
4.4	Hints	. 4-5





50ohm_test_v5.wmf

Figure 4-1 50 Ω-Output testboard schematic

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4.2 50 Ohm-Output Testboard Layout

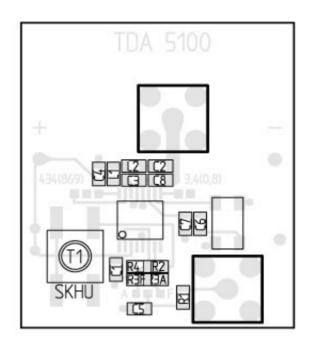
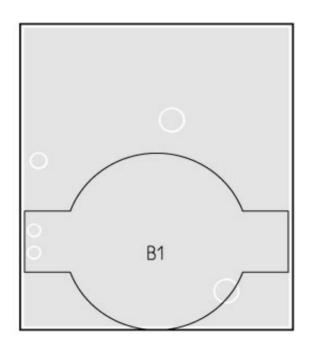




Figure 4-2 Top Side of TDA 5102-Testboard with 50 Ω -Output. It is the same testboard as for the TDA 5100.



Unten (3.00 09/14/99 tda5100_v5.tc)

Figure 4-3 Bottom Side of TDA 5102-Testboard with 50 Ω -Output. It is the same testboard as for the TDA 5100.





Table 4-1	Table 4-1 Bill of material			
Part	ASK	FSK	Specification	
	915 MHz	915 MHz		
R1	4.7 kΩ	4.7 kΩ	0805, ± 5%	
R2		12 kΩ	0805, ± 5%	
R3A	15 kΩ		0805, ± 5%	
R3F		15 kΩ	0805, ± 5%	
R4	open	open	0805, ± 5%	
C1	47 nF	47 nF	0805, X7R, ± 10%	
C2	47 pF	47 pF	0805, COG, ± 5%	
C3	2.7 pF	2.7 pF	0805, COG, ± 0.1 pF	
C4	100 pF	100 pF	0805, COG, ± 5%	
C5	1 nF	1 nF	0805, X7R, ± 10%	
C6	5.6 pF	5.6 pF	0805, COG, ± 0.1 pF	
C7	$0 \ \Omega$ Jumper	47 pF	0805, COG, ± 5% 0805, 0Ω Jumper	
C8	8.2 pF	8.2 pF	0805, COG, ± 5%	
L1	33 nH	33 nH	TOKO LL2012-J	
L2	15 nH	15 nH	TOKO LL1608-J	
Q3	14.3 MHz	14.3 MHz		
IC1	TDA 5102	TDA 5102		
B1	Battery clip	Battery clip	HU2031-1, RENATA	
T1	Push-button	Push-button	replaced by a short	
X1	SMA-S	SMA-S	SMA standing	
X2	SMA-S	SMA-S	SMA standing	

4.3 Bill of material (50 Ohm-Output Testboard)

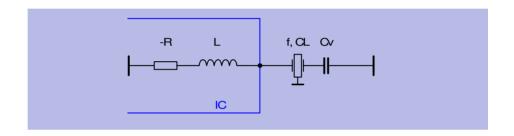
Applications



4.4 Hints

1. Application Hints on the crystal oscillator

As mentioned before, the crystal oscillator achieves a turn on time less than 1 msec. To achieve this, a NIC oscillator type is implemented in the TDA 5102. The input impedance of this oscillator is a negative resistance in series to an inductance. Therefore the load capacitance of the crystal CL (specified by the crystal supplier) is transformed to the capacitance Cv.



$$Cv = \frac{1}{\frac{1}{CL} + \omega^2 L}$$
 Formula 1)

- CL: crystal load capacitance for nominal frequency
- ω: angular frequency
- L: inductivity of the crystal oscillator

Example for the ASK-Mode:

Referring to the application circuit, in ASK-Mode the capacitance C7 is replaced by a short to ground. Assume a crystal frequency of 14.3 MHz and a crystal load capacitance of CL = 20 pF. The inductance L is specified within the electrical characteristics at 14.3 MHz to a value of 11 μ H. Therefore C6 is calculated to 7.2 pF.

$$Cv = \frac{1}{\frac{1}{CL} + \omega^2 L} = C6$$